505659702 09/06/2019

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
PENGFEI WU	07/26/2019
ASSAF NATANZON	07/30/2019
STEPHEN JAMES TODD	07/26/2019
ZHENZHEN LIN	07/26/2019

RECEIVING PARTY DATA

Name:	EMC IP HOLDING COMPANY LLC	
Street Address:	176 SOUTH STREET	
City:	HOPKINTON	
State/Country:	MASSACHUSETTS	
Postal Code:	01748	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16530936

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: paula.hardilek@chamberlainlaw.com

Correspondent Name: PAULA HARDILEK

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Address Line 4: HOUSTON, TEXAS 77002

ATTORNEY DOCKET NUMBER:	170360-039600US
NAME OF SUBMITTER:	ALY Z. DOSSA
SIGNATURE:	/Aly Z. Dossa/
DATE SIGNED:	09/06/2019

Total Attachments: 6

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PATENT 505659702 REEL: 050297 FRAME: 0980

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PATENT REEL: 050297 FRAME: 0981

ASSIGNMENT

WHEREAS, we, Pengfei Wu, Assaf Natanzon, Stephen James Todd, and Zhenzhen Lin, have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled <u>SYSTEM AND METHOD FOR DATA REGISTRATION</u>, the specification of which:

X	Is being executed on even date herewith and is about to be filed in the States Patent Office;		ed
	was filed on	as U.S. Application No	_;
[]	was patented under U.S. I	Patent Noon	_·

WHEREAS, EMC IP Holding Company LLC (hereinafter "ASSIGNEE"), a corporation organized and existing under the laws of the Commonwealth of Massachusetts and having a usual place of business at 176 South Street, Hopkinton, Massachusetts 01748 desires to acquire an interest therein in accordance with agreements duly entered into with us;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by us had this assignment and sale not been made; we hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. We hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

AND, we hereby further agree for ourselves and our executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution, reissue, divisional or continuation applications and preliminary or other statements and the

PATENT REEL: 050297 FRAME: 0982 giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, we do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives.

IN TESTIMONY WHEREOF, we have hereunto set our hands and affixed our seals as set forth below:

PATENT/Joint Assignment Dell EMC Docket No.: 115250.01; 170360-039600US

Date: かり /, 7/5

Inventor's Signature

Print full name of first inventor;

Pengfei WU

Residence:

Shanghai, China

Citizenship:

China

Mailing Address:

c/o EMC IP Holding Company LLC

176 South Street

Hopkinton, MA 01748

PATENT/Joint Assignment Dell EMC Docket No.: 115250.01; 170360-039600US

Date: 30/7/2019	\mathcal{M}
	Inventor's Signature
Print full name of second inventor:	Assaf NATANZON
Residence:	Tel Aviv, Israel
Citizenship:	Israel
Mailing Address:	c/o EMC IP Holding Company LLC 176 South Street Hopkinton, MA 01748

PATENT/Joint Assignment Dell EMC Docket No.: 115258.01; 178368-639680US

Date:

July 26 2019

Inventor's Signature

Print full name of third inventor:

Residence:

Citizenship:

Mailing Address:

Stephen James TODD

North Conway, NH, US

United States

c/o EMC IP Holding Company LLC

176 South Street

Hopkinton, MA 01748

PATENT/Joint Assignment Dell EMC Docket No.: 115250.01; 170360-039600US

Date: 7/1/6/76

Whensher Lin

Inventor's Signature

Print full name of fourth inventor:

Residence:

Citizenship:

Mailing Address:

Zhenzhen LIN

Shanghai, China

China

c/o EMC IP Holding Company LLC

176 South Street Hopkinton, MA 01748

-6-

PATENT REEL: 050297 FRAME: 0987

RECORDED: 09/06/2019